To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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To all our customers

Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note : Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

M66236FP

STANDARD CLOCK GENERATOR

DESCRIPTION

M66236 is produced using the silicon gate CMOS process. It is able to output clock input signal in sync with optional external trigger input signal.
It features excellent synchronizing precision (jitter) over a wide frequency band range.

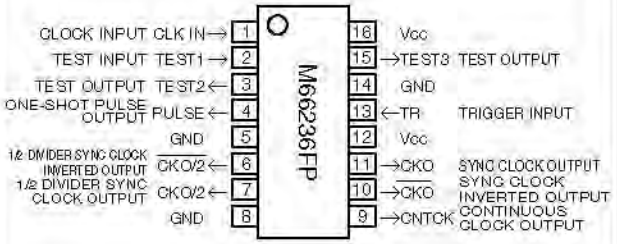
FEATURES

- 5V single power supply (5V ±5%)
- Frequency band: 12 ~ 25MHz
- Synchronizing precision (jitter): ±5ns
- Output types
  (1) Output of the same frequency as input clock, and its inversion
  (2) 1/2 divider clock output and its inversion
  (3) One-shot pulse output
  (4) Continuous clock output
- Noise in the positive direction to trigger input is removed by built-in noise killer circuit

APPLICATION

Clock phase control for horizontal synchronization

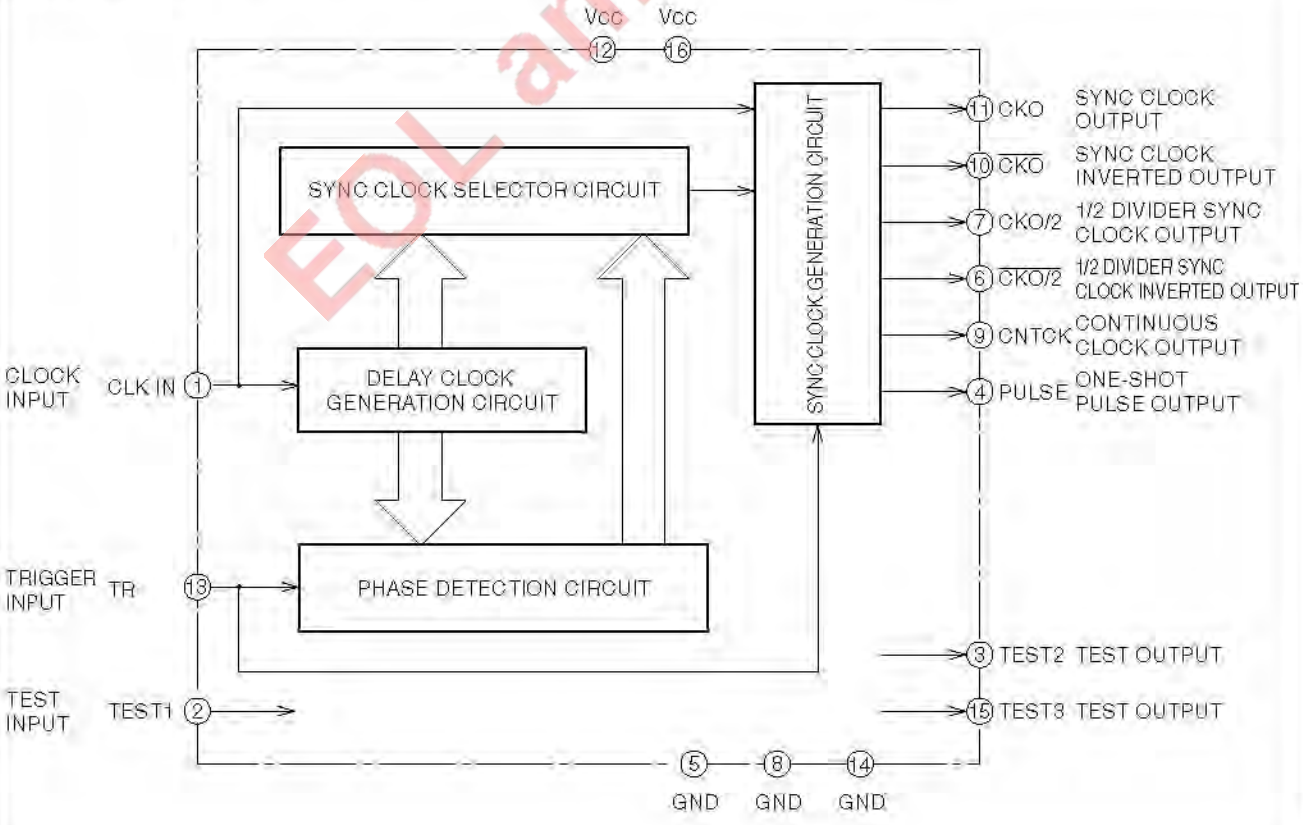
PIN CONFIGURATION (TOP VIEW)



Outline 16P2N-A

Note: Keep test pins (TEST 1 to 3) open.

BLOCK DIAGRAM



FUNCTION

M66236 standard clock generator outputs clock input signal, which is input to CLK IN, synchronously with optional trigger signal, which is input to TR.

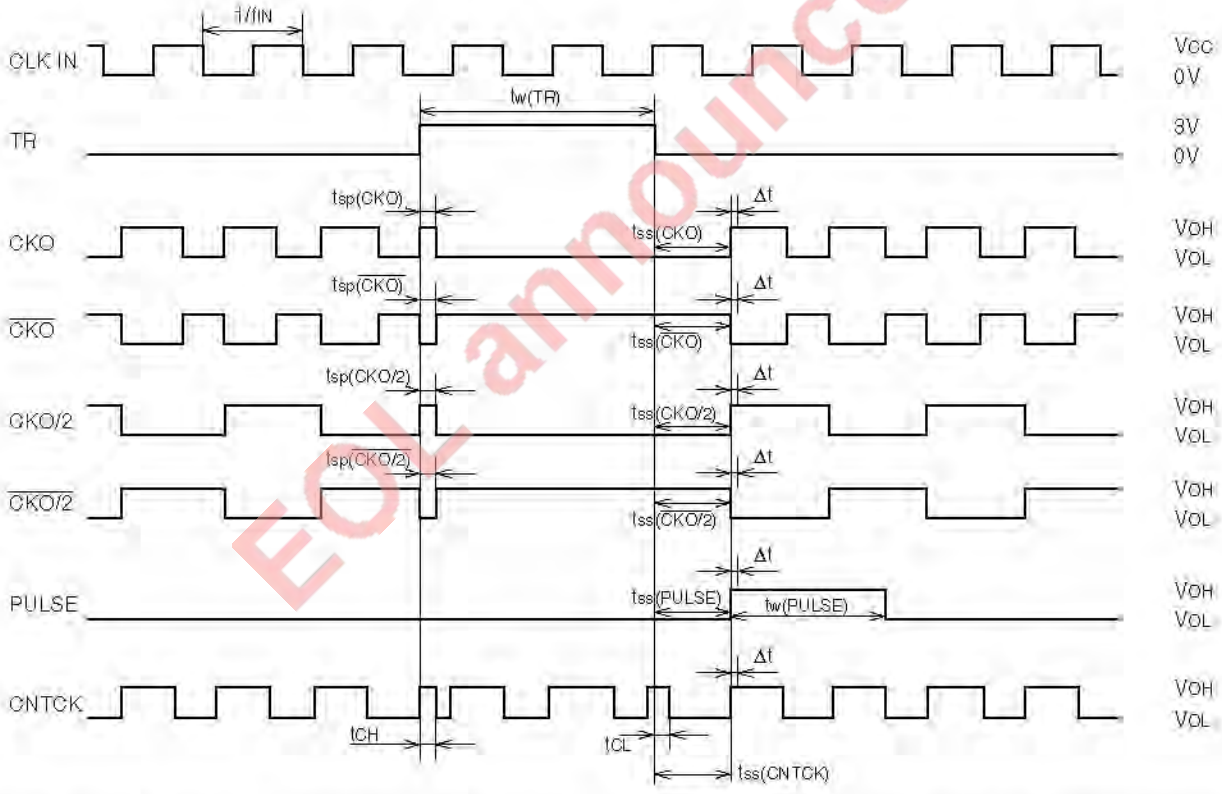
Sync clock output timing is determined by trigger input signal fall edge. Time-lag between trigger input signal fall edge and sync clock output equals the sum of clock input signal "L" pulse width and M66236 internal delay. Variation in this lag (Δt) is ±5ns, ensuring excellent synchronizing accuracy.

There are six types of outputs: synchronous clock output (CKO), synchronous clock inverted output ($\overline{CKO}$), 1/2 divider synchronous clock output (CKO/2), 1/2 divider synchronous clock inverted output ($\overline{CKO/2}$), one-shot pulse output (PULSE) and continuous clock output (CNTCK).

From synchronous clock output (CKO), sync clock of the same frequency as clock input signal is output. From synchronous clock inverted output ($\overline{CKO}$), inverted signal of sync clock output from CKO is output. From 1/2 divider synchronous clock output (CKO/2), 1/2 divider signal of sync clock output from CKO is output. From 1/2 divider synchronous clock inverted output ($\overline{CKO/2}$), inverted signal of that output from CKO/2 is output.

From one-shot pulse output (PULSE), one-shot pulse which is almost equal to two cycles of clock input signal is output after trigger input signal falls. From continuous clock output (CNTCK), sync clock is output when trigger input signal is on "L" level; when trigger input signal is on "H" level, clock input signal, which is input to CLK IN, is output.

All these outputs but continuous clock output are suspended when trigger input signal is on "H" level: Synchronous clock output, 1/2 divider synchronous clock output and one-shot pulse output stay on "L" level, and synchronous clock inverted output and 1/2 divider synchronous clock inverted output stay on "H" level.



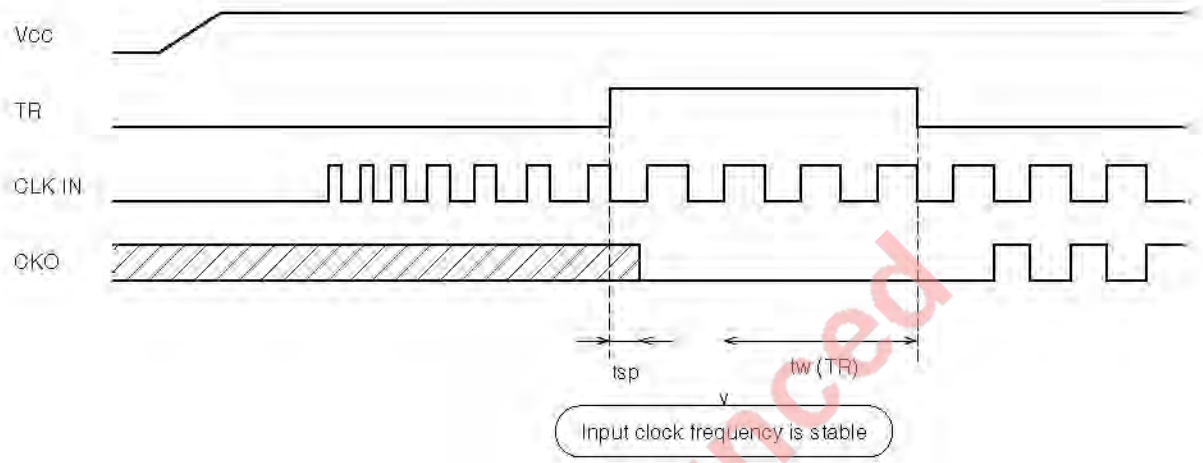
Note 1: tss (CKO, $\overline{CKO}$, CKO/2, $\overline{CKO/2}$ and PULSE) equals the sum of input clock "L" width and α. Value α refers to internal delay in M66236. Under environment where temperature and Vcc do not change, value α and tss are kept constant. Dispersion of tss under such conditions is defined as Δt [synchronizing precision (jitter)].

Note 2: Outputs (CKO, $\overline{CKO}$, CKO/2, $\overline{CKO/2}$ PULSE and CNTCK) are unknown until trigger input TR reaches "H" level for the first time after power-on.

After Power-on Procedure

After power-on, M66236 status is unknown till the trigger input being set to the "H" level.
To get a accurate sync clock output, please keep a following procedure.

Please hold the trigger input "H" level during more than tw(TR) after the input clock frequency being stable.
Also, in case of changing the clock input frequency(f_{IN}), please keep the same procedure.



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Ratings	Unit
V_{CC}	Supply voltage		−0.5 ~ +7.0	V
V_I	Input voltage		−0.5 ~ V_{CC} + 0.5	V
V_O	Output voltage		−0.5 ~ V_{CC} + 0.5	V
Pd	Power dissipation	When mounted	600	mW
Tstg	Storage temperature		−65 ~ 150	°C

RECOMMENDED OPERATING CONDITIONS (Ta = 0 ~ 70°C unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Typ	Max	
V_{CC}	Supply voltage	4.75	5	5.25	V
GND	Supply voltage		0		V
V_I	Input voltage	0		V_{CC}	V
V_O	Output voltage	0		V_{CC}	V
Topr	Operating temperature	0		70	°C

ELECTRICAL CHARACTERISTICS (Ta = 0 ~ 70°C, V_{CC} = 5V ±5%, GND = 0V)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
V_{IH}	"H" input voltage	TR	2			V
V_{IL}	"L" input voltage				0.8	V
V_{IH}	"H" input voltage	CLK IN	0.8 × V_{CC}			V
V_{IL}	"L" input voltage				0.2 × V_{CC}	V
V_{OH}	"H" output voltage	GND = 0V, I_{OH} = −4mA	V_{CC} − 0.8			V
V_{OL}	"L" output voltage	GND = 0V, I_{OL} = 4mA			0.55	V
I_{CC} (s)	Supply current (static)	GND = 0V, V_I = V_{CC} or GND			50	µA
I_{CC} (a)	Supply current (active)	GND = 0V, fIN = 25MHz, V_I = V_{CC} or GND			65	mA
I_{IH}	"H" input current	GND = 0V, V_I = V_{CC}			+1	µA
I_{IL}	"L" input current	GND = 0V, V_I = 0V			−1	µA
CI	Input capacitance				10	pF

TIMING REQUIREMENTS (Ta = 0 ~ 70°C, V_{CC} = 5V ±5%, GND = 0V)

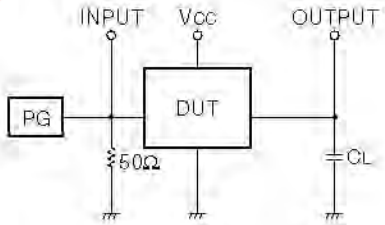
Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
fIN	Clock input frequency		12		25	MHz
fDUTY	Clock input duty		40		60	%
tw(TR)	Trigger input "H" pulse width		400			ns
tr	Clock input rise time				8	ns
tf	Clock input fall time				8	ns

SWITCHING CHARACTERISTICS (Ta = 0 ~ 70°C, Vcc = 5V ±5%, GND = 0V)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
Δt	Synchronizing precision (jitter)	CL=15pF			±5	ns
tss(CKO)	Sync clock output start time				tLp + 50	ns
tss($\overline{CKO}$)	Sync clock inverted output start time					ns
tss(CKO/2)	1/2 divider sync clock output start time				tLp + 50	ns
tss($\overline{CKO/2}$)	1/2 divider sync clock inverted output start time					ns
tss(PULSE)	One-shot pulse output start time				tLp + 50	ns
tss(CNTCK)	Continuous clock output start time				tLp + 50	ns
tsp(CKO)	Sync clock output stop time				40	ns
tsp($\overline{CKO}$)	Sync clock inverted output stop time					ns
tsp(CKO/2)	1/2 divider sync clock output stop time				40	ns
tsp($\overline{CKO/2}$)	1/2 divider sync clock inverted output stop time					ns
tw(PULSE)	One-shot pulse output width		2tp − 10		2tp + 10	ns
tCH	Sync clock-Input clock switching time				40	ns
tCL	Input clock-Sync clock switching time				30	ns
fODUTY(CKO)	Sync clock output duty		30		70	%
fODUTY($\overline{CKO}$)	Sync clock inverted output duty					%

- $t_p = 1/f_{IN}$, $t_{Lp} = t_p \times (100 - f_{DUTY})/100$
- Switching test waveform
  - Input pulse level CLK IN: 0 to Vcc
    TR: 0 to 3V
  - Input pulse rise time: 3ns
  - Input pulse fall time : 3ns
  - Criterial voltage
    - Input voltage CLK IN: Vcc/2
      TR: 1.3V
    - Output voltage: Vcc/2 for all outputs
- Capacitance: CL includes stray wiring capacitance and probe input capacitance.

TEST CIRCUIT



TIMING DIAGRAM